

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL		UNITS
Drain-Source Volt.(1)	VDSS	1000	Vdc
Drain-Gate Voltage (R _{GS} =1.0M Ω) (1)	VDGR	1000	Vdc
Gate-Source Voltage Continuous	VGS	± 30	Vdc
Drain Current Continuous (T _c = 25°C)	ID	4.4	Adc
Drain Current Pulsed(3)	IDM	17.6	A
Total Power Dissipation	PD	150	W
Power Dissipation Derating > 25°C		1.2	W/°C
Operating & Storage Temp.	TJ/Tslg	-55 TO +150	°C
Thermal Resistance	RthJc	0.8	°C/W
Max.Lead temperature	TL	300	°C

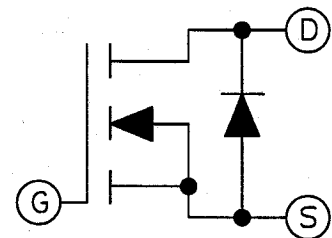
1000V, 4.4A, 4.0 Ω

SDF4NA100 SXH

FEATURES

- RUGGED PACKAGE
- HI-REL CONSTRUCTION
- COPPER CORED 52 ALLOY PINS
- LOW IR LOSSES
- LOW THERMAL RESISTANCE
- OPTIONAL MIL-S-19500 SCREENING

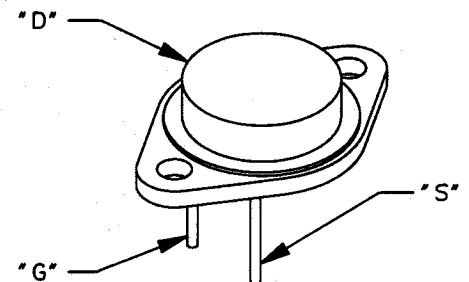
SCHEMATIC



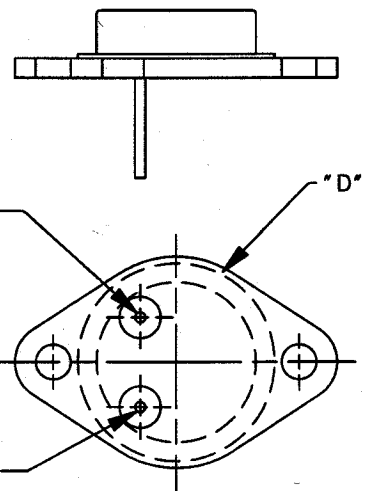
ELECTRICAL CHARACTERISTICS T_c = 25°C (UNLESS OTHERWISE SPECIFIED)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain-source Breakdown Volt.	V(BR)DSS	VGS=0V ID=250 μ A	1000	-	-	V
Gate Threshold Voltage	VGS(TH)	VDS=VGS ID=1 MA	2.0	-	4.0	V
Gate Source Leakage	IGSS	VGS= ± 30 V	-	-	100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=MAX.RATING VGS=0	-	-	250	μ A
Static Drain-Source On-State Resistance(1)	RDS(ON)	VDS=0.8 MAX.RATING VGS=0 TJ=125°C	-	-	1000	μ A
Input Capacitance	CISS	VGS=10 V ID=2.2A	-	-	4.0	Ω
Output Capacitance	COSS	VGS=0V VDS=25 V f=1.0 MHz	-	805	-	pF
Reverse Transfer Capacitance	CRSS		-	115	-	pF
Turn-On Delay	td(on)	VDD=500V RG=1.8 Ω ID=4.4A VGS=15V	-	-	23	ns
Rise Time	tr	(MOSFET switching times are essentially independent of operating temp.)	-	-	20	ns
Turn-Off Delay	td(off)		-	-	50	ns
Fall Time	tf		-	-	27	ns
Total Gate Charge (Gate-Source Plus Gate-Drain)	Qg	VGS=10V, ID=4.4A VDS=0.5 MAX.RATING (Gate charge is essentially independent of the operating temperature)	-	-	55	nC
Gate-Source Charge	Qgs		-	-	6.5	nC
Gate-Drain ("Miller") Charge	Qgd		-	-	27	nC

"ISOMETRIC VIEW"



PIN CONFIGURATION "0" SXH



SOURCE-DRAIN DIODE RATINGS & CHARACT. T_c = 25°C (UNLESS OTHERWISE SPECIFIED)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Continuous Source Current (Body Diode)	IS	Modified MOSFET symbol showing the integral reverse P-N junction rectifier (See schematic)	-	-	4.4	A
Pulse Source Current (Body Diode) (1)	ISM		-	-	17.6	A
Diode Forward Voltage (2)	VSD	IF=4.4A VGS=0V Tc=+25°C	-	-	1.3	V
Reverse Recovery Time	trr	Tc=+25°C IF=4.4A	-	-	580	ns
Reverse Recovery Charge	Qrr	di/dt=100A/ μ S	-	1.65	-	μ C

(1) TJ = 25°C to 150°C.

(2) Pulse test: Pulse Width < 300 μ S, Duty Cycle < 2%.

(3) Repetitive Rating: Pulse Width limited By Max. junction Temperature.